# L-556 Solution Coated Epoxy Prepreg, Heat Resistant



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## **Product Data Sheet**

#### Description

L-556 is a heat resistant modified epoxy prepreg. It is a versatile product that the designer may use for structural or general purpose applications.

#### Advantages of L-556

- ✤ L-556 was designed for end users that require a structural prepreg, but have temperature requirements above most performance envelopes of the classical laminating epoxy prepregs.
- ✤ L-556 is especially suited for long term exposure to temperatures as high as 350°F (177°C).
- Low temperature cures allow the production of high temperature parts on low cost tools.

#### Physical Properties on 7781 Glass Fabric

- Standard Weight: 0.100 lbs/ft<sup>2</sup> (488 g/m<sup>2</sup>)
- Standard Resin Content: 38% by weight
- Volatile Content: Less than 1.5% by weight
- Standard Tack: Medium
- Cured Ply Thickness: 0.010" (0.254 mm)
- Other Weights, Resin Contents, and Fabrics are Available.

#### Availability

- 38", 50", or 60" wide and 60 yards long (97 cm, 127 cm, 152 cm x 55 m)
- Many fabrics and styles are available in up to 60" width in rolls up to 100 yards long (152 cm x 91 m).

### Shelf Life

- 12 months at 0°F (-18°C)
- 6 months at 40°F (4°C)
- 14 days at Room Temperature (70°F or 21°C)



#### **Cure Cycles**

- 90 minutes at 350°F (177°C), or
- 120 minutes at 300°F (149°C), or
- 180 minutes at 275°F (135°C), or
- 240 minutes at 235°F (113°C).
- <u>Typical Cycle</u>: RT to 265 +0/-10°F (129 +0/-6°C) in 20-30 minutes, hold at 265 +0/-10°F (129 +0/-6°C) for 20-25 minutes, raise to 350 +0/-10°F (177 +0/-6°C) in 20-30 minutes, hold at 350 +0/-10°F (177 +0/-6°C) for 120 ± 10 minutes. This cure is in an autoclave, blanket press, or platen press at 45-85 PSI (0.31-0.59 MPa).

#### **Mechanical Data**

	LAMINATE PROPERTIES		
PROPERTY	VACUUM BAG CURE	40 PSI (0.28 MPa) CURE	TEST METHOD
ULTIMATE TENSILE STRENGTH			
Room Temperature (RT)	61 KSI (421 MPa)	63 KSI (434 MPa)	ASTM D638
350°F (177°C)	48 KSI (331 MPa)	50 KSI (345 MPa)	ASTM D638
TENSILE MODULUS			
Room Temperature (RT)	3.0 MSI (21 GPa)	3.2 MSI (22 GPa)	ASTM D638
COMPRESSIVE STRENGTH			
Room Temperature (RT)	83 KSI (572 MPa)	65 KSI (448 MPa)	ASTM D695
350°F (177°C)	40 KSI (276 MPa)	53 KSI (366 MPa)	ASTM D695
COMPRESSIVE MODULUS			
Room Temperature (RT)		4.4 MSI (30 GPa)	ASTM D695
350°F (177°C)		3.6 MSI (25 GPa)	ASTM D695
ULTIMATE FLEXURAL STRENGTH			
Room Temperature (RT)	102 KSI (703 MPa)	103 KSI (710 MPa)	ASTM D790
350°F (177°C)	68 KSI (469 MPa)	82 KSI (566 MPa)	ASTM D790
420°F (216°C)	55 KSI (379 MPa)	59 KSI (407 MPa)	ASTM D790
500°F (260°C)		25 KSI (172 MPa)	ASTM D790
FLEXURAL MODULUS		. ,	
Room Temperature (RT)	3.4 MSI (23 GPa)	3.5 MSI (24 GPa)	ASTM D790
350°F (177°C)		3.4 MSI (23 GPa)	ASTM D790

**CAUTION:** Do not build any section of L-556 over 0.250" (6.35 mm) thick. Please contact the J.D. Lincoln, Inc. company for special curing requirements for parts thicker than 0.250" (6.35 mm).

#### NOTICE:

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